

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Jyong Sik JANG</td> <td>05/04/2010</td> </tr> <tr> <td>Oh Seok KWON</td> <td>05/04/2010</td> </tr> <tr> <td>Seon Joo PARK</td> <td>05/04/2010</td> </tr> </tbody> </table>		Name	Execution Date	Jyong Sik JANG	05/04/2010	Oh Seok KWON	05/04/2010	Seon Joo PARK	05/04/2010		
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RECEIVING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>SNU R&DB FOUNDATION</td> </tr> <tr> <td>Street Address:</td> <td>San 56-1, Sillim-dong, Gwanak-gu</td> </tr> <tr> <td>City:</td> <td>Seoul</td> </tr> <tr> <td>State/Country:</td> <td>REPUBLIC OF KOREA</td> </tr> <tr> <td>Postal Code:</td> <td>151-744</td> </tr> </table>		Name:	SNU R&DB FOUNDATION	Street Address:	San 56-1, Sillim-dong, Gwanak-gu	City:	Seoul	State/Country:	REPUBLIC OF KOREA	Postal Code:	151-744
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Application Number:	12766280										
CORRESPONDENCE DATA											
Fax Number: (703)205-8050 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 703-205-8000 Email: yolanda.askew-sampson@bskb.com Correspondent Name: BIRCH, STEWART, KOLASCH & BIRCH, LLP Address Line 1: P.O. BOX 747 Address Line 4: FALLS CHURCH, VIRGINIA 22040-0747											
ATTORNEY DOCKET NUMBER:	5097-0167PUS1										
NAME OF SUBMITTER:	Craig A. McRobbie										
Total Attachments: 2 source=20100510Assignment#page1.tif source=20100510Assignment#page2.tif											

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PATENT
REEL: 024389 FRAME: 0636

BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application No. 12/766,280

Filed April 23, 2010

Insert Name(s)
of Inventor(s)

*** (Given Name FAMILY NAME (ALL CAPS)) ***

WHEREAS, Jyong Sik JANG; Oh Seok KWON; Seon Joo PARK (hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in:

Insert Title
of Invention

METHOD FOR FABRICATING NOVEL HIGH-PERFORMANCE FIELD-EFFECT TRANSISTOR BIOSENSOR BASED ON CONDUCTIVE POLYMER NANOMATERIALS FUNCTIONALIZED WITH ANTI-VEGF ADAPTER

for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application)

Insert Date
of Signing of
Application

on May 4, 2010; and

Insert Name
of Assignee
Insert Address
of Assignee

WHEREAS, SNU R&DB FOUNDATION

of San 56-1, Sillim-dong, Gwanak-gu, Seoul 151-744, Republic of Korea

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

CHECK BOX
IF APPROPRIATE



in any foreign countries.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

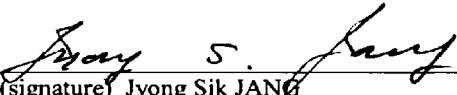
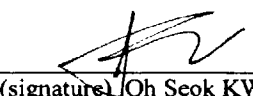
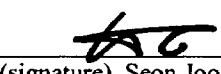
The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date <u>May 4, 2010</u> ,	Name of Inventor <u></u> (signature) Jyong Sik JANG
Date <u>May 4, 2010</u> ,	Name of Inventor <u></u> (signature) Oh Seok KWON
Date <u>May 4, 2010</u> ,	Name of Inventor <u></u> (signature) Seon Joo PARK